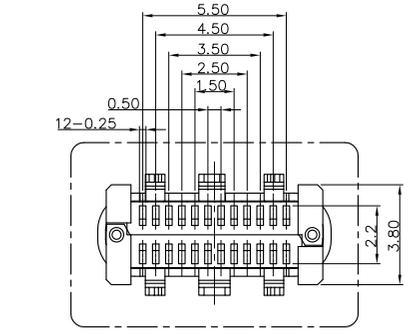
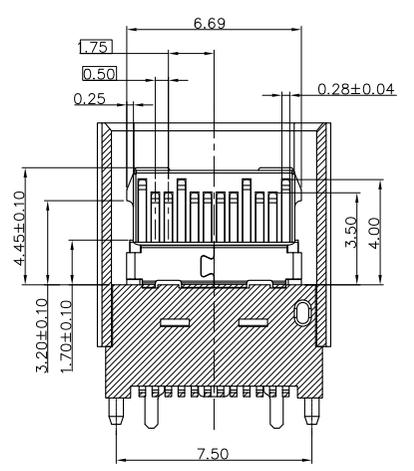
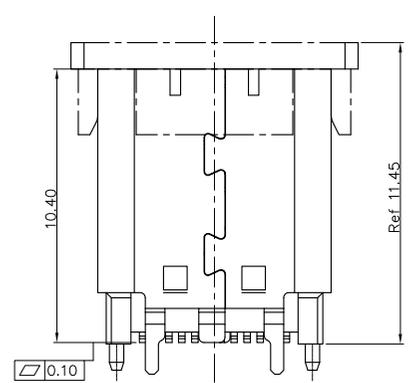
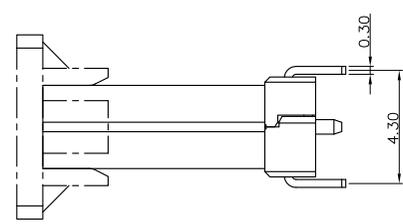
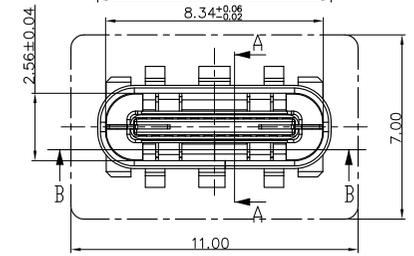
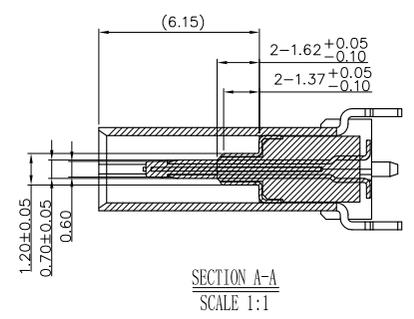
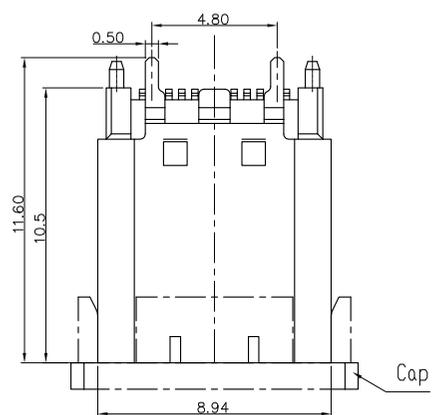


1 2 3 4 5 6 7 8 9 10

MAPX	MODIFICATION	DATE

A  
B  
C  
D  
E  
F  
G

A  
B  
C  
D  
E  
F  
G



- NOTES:
- MATERIAL:
    - MOLDING: LCP UL94 V-0
    - CONTACT: COPPER ALLOY.
    - GOLD PLATED 30u" Min ON CONTACT AREA, 100u" Min TIN (LEAD FREE) ON SOLDER AREA,
    - SHELL: SUS304-H, T=0.30±0.03mm
    - 50u" NICKEL PLATING OVER ALL.
    - SHILD: SUS304-H, T=0.12±0.03mm
  - MECHANICAL:
    - INSERTION: 5~20N.
    - EXTRACTION: 8~20N.
    - DURABILITY: 10000 CYCLES
  - ELECTRICAL:
    - CURRENT: 5A MIN FOR VBUS;
    - 0.25A MIN FOR OTHER.
    - VOLTAGE: 5VAC MAX
    - WITHSTANDING VOLTAGE: 100V AC.
    - CONTACT RESISTANCE: 40mΩ MAX.
    - INSULATION RESISTANCE: 100MΩ MIN.
  - ENVIRONMENTAL
    - TEMPERATURE RANGE -55°C ~ +85°C

<b>产品图</b> PRODUCT CHART DWG					
公差一览表 TOLERANCE UNLESS OTHERWISE		单位	制图	制图料号	制图料号
X.	±0.25	MM	Z-Y-B	PRODUCT PART NO.	C918-EC418K2022Y40003
.X	±0.20	比例	审核	产品名称	TYPE-C3.1母座无边180度贴片10.5LCP黑胶24PIN
.XX	±0.15	SCALE	CHKD	PRODUCT NO.	
.XXX	±0.10	日期	核准	角法	版本
		DATE	APPD	VIEW	VER
		2014.05.15		⊕	AO

1 2 3 4 5 6 7 8 9 10